

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

re Patent Application of:

Shinsuke Kishi et al

Art Unit: 1732

Application No.: 09/778,805

Examiner: J.L. Heitbrink

Filed: February 8, 2001

Confirmation No.: 6154

For: An Injection Molding Apparatus and A Method Therefor

RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Notice of Non-Compliant Amendment mailed March 25, 2003, for which one month was allotted for response, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begin on page 2 of this paper.

Remarks/Arguments begin on page 8 of this paper.